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TS4040

2.5V micropower shunt voltage reference

Features

- 2.5V output voltage
- Ultra low current consumption: 40µA typ.
- High precision @ 25°C: ±2% and ±1%
- High stability when used with capacitive loads
- Industrial temperature range:-40°C to +85°C
- 150ppm/°C maximum temperature coefficient

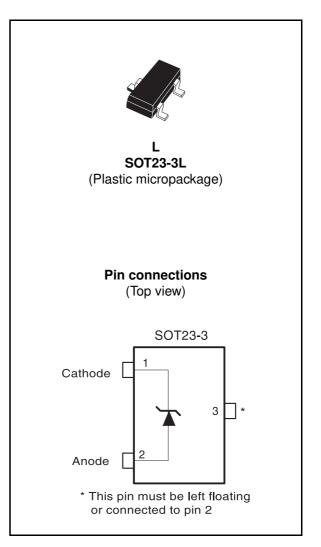
Applications

- Computers
- Instrumentation
- Battery chargers
- Switch mode power supply
- Battery operated equipments

Description

The TS4040 is a low power shunt voltage reference providing a stable 2.5V output voltage over the industrial temperature range (-40°C to +85°C). Available in SOT23-3 surface mount package, it can be designed in applications where space saving is critical.

The low operating current is a key advantage for power restricted designs. In addition, the TS4040 is very stable and can be used in a broad range of application conditions.



1

Absolute maximum ratings and operating conditions

Symbol	Parameter	Value	Unit	
I _k	Reverse breakdown current	20	mA	
۱ _f	Forward current	10	mA	
Pd	Power dissipation ⁽¹⁾ SOT23-3	360	mW	
T _{stg}	Storage temperature	-65 to +150	°C	
ESD	Human body model (HBM) ⁽²⁾	2	kV	
	Machine model (MM) ⁽³⁾	200	V	
T _{lead}	Lead temperature (soldering, 10 seconds)	260	°C	

Table 1. Absolute maximum ratings (AMR)

1. Pd is calculated with $T_{amb} = 25^{\circ}C$, $T_{junction} = 150^{\circ}C$ and $R_{thja} = 340^{\circ}C/W$ for the SOT23-3 package.

2. Human body model: 100pF discharged through a $1.5k\Omega$ resistor between two pins of the device, done for all couples of pin combinations with other pins floating.

 Machine model: a 200pF cap is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor < 5Ω), done for all couples of pin combinations with other pins floating.

Table 2.Operating conditions

Symbol	Parameter	Value	Unit
I _{k-min}	Minimum operating current	65	μA
I _{k-max}	Maximum operating current	15	mA
T _{oper}	Operating free air temperature range	-40 to +85	°C



2 Electrical characteristics

	(unless otherwise specifical)						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
	Reverse breakdown voltage	I _k = 100μA	2.45	2.5	2.55	V	
V _k	Reverse breakdown voltage tolerance	$I_{k} = 100\mu A$ -40°C < T _{amb} < +85°C	-50 -74		50 74	mV	
I _{k-min}	Minimum operating current	T = 25°C -40°C < T _{amb} < +85°C		40	65 70	μA	
$\Delta V_{ref}\!/\!\Delta T$	Average temperature coefficient	I _k = 100μA		30	150	ppm/°C	
$\Delta V_k / \Delta I_k$	Reverse breakdown voltage change	$I_{k-min} < I_k < 1mA$ -40°C < T _{amb} < +85°C		0.4	1 1.2	mV	
	with operating current range	1mA < I _k < 15mA -40°C < T _{amb} < +85°C		2.5	8 10	ni v	
P	Poverse static impedance	$I_k = I_{k-min}$ to 1mA -40°C < T _{amb} < +85°C		0.4	1 1.2	0	
R _{ka}	Reverse static impedance	I _k = 1 to 15mA -40°C < T _{amb} < +85°C		0.2	0.6 0.7	Ω	
K _{vh}	Long term stability	$I_{k} = 100 \mu A, t = 1000 hrs$		120		ppm	
En	Wide band noise	I _k = 100μA 10Hz < f < 10kHz		35		nV/√Hz	

Table 3. TS4040E (2% precision) $T_{amb} = 25^{\circ}C^{(1)}$ (unless otherwise specified)

1. Limits are 100% production tested at 25°C. Behavior at the temperature range limits is guaranteed through correlation and by design.

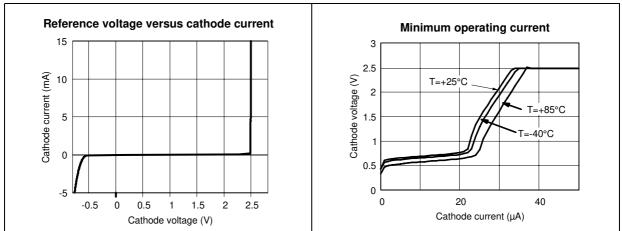
Table 4. TS4040D (1% precision) $T_{amb} = 25^{\circ}C^{(1)}$ (unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
	Reverse breakdown voltage	I _k = 100μA	2.475	2.5	2.525	V	
V _k	Reverse breakdown voltage tolerance	$I_{k} = 100\mu A$ -2 -40°C < T _{amb} < +85°C -4			25 49	mV	
I _{k-min}	Minimum operating current	T = 25°C -40°C < T _{amb} < +85°C		40	65 70	μA	
$\Delta V_{ref}\!/\Delta T$	Average temperature coefficient	I _k = 100μA		30	150	ppm/°C	
$\Delta V_k / \Delta I_k$	Reverse breakdown voltage change	$I_{k-min} < I_k < 1mA$ -40°C < T _{amb} < +85°C		0.4	1 1.2	mV	
	with operating current range	1mA < I _k < 15mA -40°C < T _{amb} < +85°C		2.5	8 10	iii v	
D		I _k = I _{k-min} to 1mA -40°C < T _{amb} < +85°C		0.4	1 1.2	Ω	
R _{ka}	Reverse static impedance	I _k = 1mA to 15mA -40°C < T _{amb} < +85°C		0.2	0.6 0.7	52	
K _{vh}	Long term stability	$I_{k} = 100 \mu A, t = 1000 hrs$		120		ppm	
En	Wide band noise	I _k = 100μA 10Hz < f < 10kHz		35		nV/√Hz	

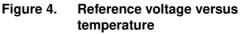
1. Limits are 100% production tested at 25°C. Behavior at the temperature range limits is guaranteed through correlation and by design.



Figure 1. Reference voltage versus cathode Figure 2. current







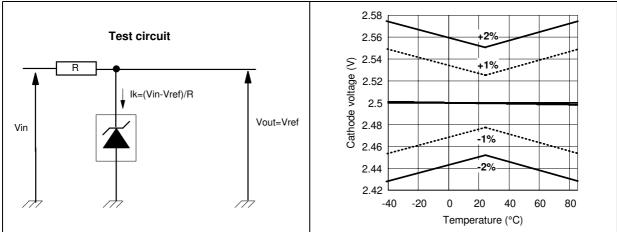


Figure 5. Static impedance Rka versus temperature

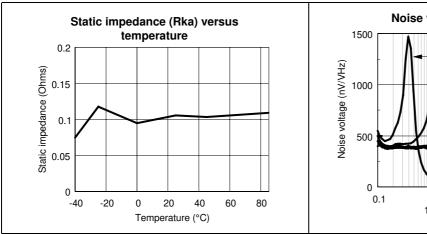
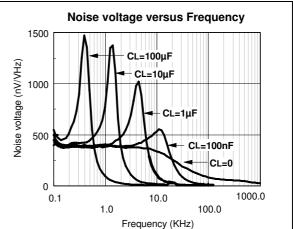


Figure 6. Noise voltage versus frequency



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Minimum operating current

Test circuit for pulse response at Figure 7. I_k=100μA

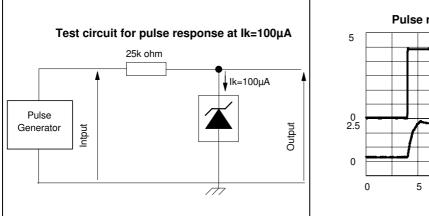


Figure 9. Test circuit for pulse response at I_k=100µA (detailed part)

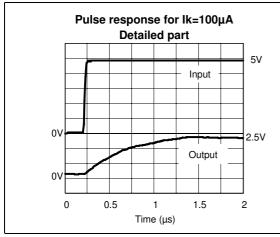


Figure 11. Test circuit for pulse response at l_k=1mA

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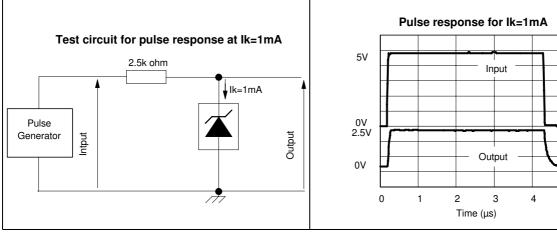


Figure 8. Pulse response for Ik=100µA

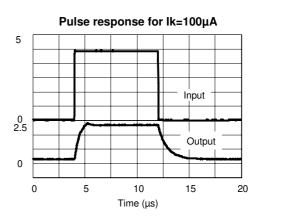


Figure 10. Test circuit for pulse response at Ik=100µA (detailed part)

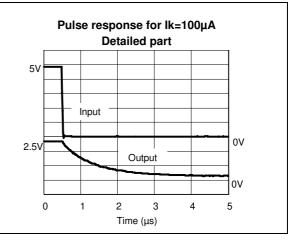
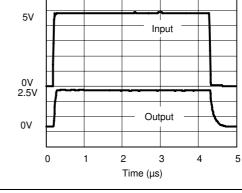
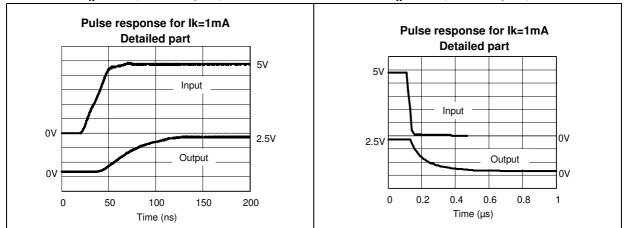


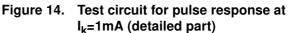
Figure 12. Pulse response at Ik=1mA





3 Package information

In order to meet environmental requirements, STMicroelectronics offers these devices in ECOPACK[®] packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an STMicroelectronics trademark. ECOPACK specifications are available at: <u>www.st.com</u>.



	00120 0 pu	ckage mecha		niona			
D.(Dimensions						
Ref.		Millimeters			Mils		
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А	0.890		1.120	35.05		44.12	
A1	0.010		0.100	0.39		3.94	
A2	0.880	0.950	1.020	34.65	37.41	40.17	
b	0.300		0.500	11.81		19.69	
С	0.080		0.200	3.15		7.88	
D	2.800	2.900	3.040	110.26	114.17	119.72	
E	2.100		2.64	82.70		103.96	
E1	1.200	1.300	1.400	47.26	51.19	55.13	
е		0.950			37.41		
e1		1.900			74.82		
L	0.400		0.600	15.75		23.63	
L1		0.540			21.27		
k	0°		8°	0°		8°	
SEATING PLANE C C C C C C C C C C C C C C C C C C C							



4 Ordering information

Table 5. Order codes

Part number Precision Te		Temperature range	Package	Packing	Marking
TS4040EILT-2.5	2%			-3 Tape & reel	L243
TS4040DILT-2.5	1%	-40 0 10 +05 0	30123-3	Tape & Teer	L242

5 Revision history

Table 6.Document revision history

Date	Revision	Changes
14-Mar-2002	1	Initial release.
20-Aug-2007 2		Removed TO-92 package information. Format update.

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